



光继电器

Photo Relay

QXY259

宁波群芯微电子股份有限公司
NINGBO QUNXIN MICROELECTRONICS CO., LTD.

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概述 Description

QXY259是一款高压继电器，通过高压输出检测器电路光耦合到AlGaAs红外发光二极管（LED）输入级。高压输出检测器电路由一个高速光伏二极管阵列和驱动电路组成，用于接通/断开两个分立的高压MOSFETs。

The QXY259 series is a high-voltage Photo MOSFET. It is optically coupled to the AlGaAs infrared light-emitting diode (LED) input stage optically coupled to a high-voltage output detector circuit. The high voltage output detector circuit consists of a high-speed photovoltaic diode array and driver circuitry to switch on/off two discrete high-voltage MOSFETs.

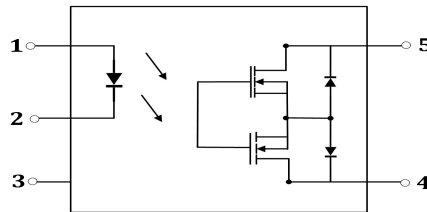
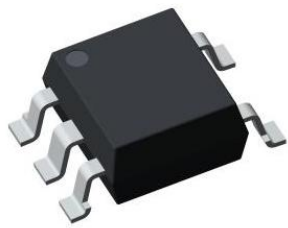
特性 Features

- 负载电压：1800V
Load voltage: 1800V
- 输入-输出隔离电压 ($V_{ISO}=5000 V_{rms}$)
High isolation voltage between input and output($V_{ISO}=5000 V_{rms}$)
- 工作温度：-40°C~+105°C
Operating Temperature: -40°C~+105°C
- 符合加强绝缘标准
Meet reinforced insulation standards
- 良好的成本效益
Good cost-performance

应用 Applications

- 蓄电池绝缘电阻测量/漏电检测
Battery insulation resistance measurement/leakage detection
- 汽车电池 BMS 拓扑结构
Automotive battery BMS topological structure
- 测量仪器
Measuring instruments
- 数据通信设备
Data communication equipment

封装和原理图 Package and Schematic Diagram



Pin Configuration

- 1. AN
- 2. CA
- 3. NC
- 4. D1
- 5. D2

产品型号命名规则 Order Code

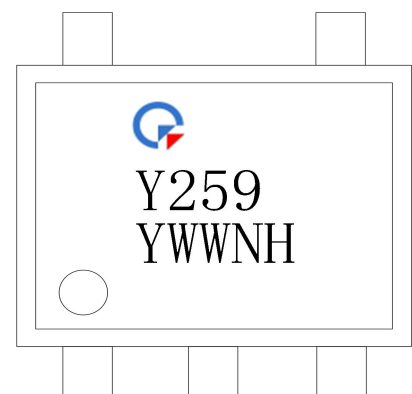
QX Y259 - UN Y - W (V) (ZZ)

① ② ③ ④ ⑤ ⑥ ⑦

- ① 公司代码 Company Code (QX: 群芯 Qunxin)
- ② 产品系列 Product Series (Y259: Y259)
- ③ 框架类型 Lead Frame (Cu: 铜框架 Copper)
- ④ 树脂类型 Epoxy Type (H: 无卤 Halogen-free)
- ⑤ 封装形式 Package (S: SMD)
- ⑥ 器件工作温度范围 Device Operating Temperature Range (特殊范围需填或者空白 Special Range need to be filled in or left blank)
- ⑦ 内部补充代码 Internal Supplementary Code (数字或者空白 Number or None)

印字信息 Marking Information

- 印字中“”为群芯品牌 LOGO
“”denotes LOGO
- 第二行印字中“Y”代表年份: A(2018), B(2019), C(2020).....
In the second line, “Y”denotes YEAR: A(2018), B(2019), C(2020).....
- 印字中“WW”代表周号
“WW”denotes Week’s number.
- 印字中“N”代表星期几
“N”denotes the day of the week.
- 第二行印字中的“H”代表无卤
In the second line, “H”denotes Halogen-free



绝缘和安规信息 Insulation and Safety related specifications

项目 Item	符号 Symbol	数值 Value	单位 Unit	备注 Note
爬电距离 Creepage Distance	L	7.0	mm	从输入端到输出端，沿本体最短距离路径 Measured from input terminals to output terminals, shortest distance path along body.
电气间隙 Clearance Distance	L	7.0	mm	从输入端到输出端，通过空气的最短距离 Measured from input terminals to output terminals, shortest distance through air.
绝缘距离 Insulation Thickness	DTI	0.4	mm	发射器和探测器之间的绝缘厚度 Insulation thickness between emitter and detector.
峰值隔离电压 Peak Isolation Voltage	V_{IORM}	1500	V_{peak}	DIN/EN/IEC EN60747-5-5.
瞬态隔离电压 Transient isolation voltage	V_{IOTM}	7000	V_{peak}	DIN/EN/IEC EN60747-5-5.
隔离电压 Isolation Voltage	V_{ISO}	5000	V_{rms}	For 1 minute.

极限参数 Absolute Maximum Ratings ($T_A=25^{\circ}\text{C}$)

参数 Parameter		符号 Symbol	额定值 Rating	单位 Unit	备注 Note
发射端 Input	LED 正向电流 LED Forward Current	I _F	50	mA	T _A = −40°C to +105°C
	LED 反向电压 LED Reverse Voltage	V _R	5	V	T _A = −40°C to +105°C
	峰值正向电流 Peak Forward Current	I _{FP}	1	A	f = 100 Hz, duty cycle = 0.1%
	输入功率 Power Dissipation	P _{in}	75	mW	
接收端 Output	持续负载电流 Continuous Load Current	I _L	0.05	A	
	峰值负载电流 Peak Load Current	I _{peak}	0.10	A	100 ms (1 pulse) V _L =DC
	雪崩电流 avalanche current	I _{AV}	0.6	mA	t=1min(continuous) , In the off state
	输出功率 Power Dissipation	P _{out}	360	mW	
总功耗 Total Power Dissipation		P _{tot}	410	mW	
输入输出瞬时耐受电压 Isolation Voltage		V _{ISO}	5000	V _{rms}	
工作温度 Operating Temperature		T _{opr}	−40~+105	°C	
存储温度 Storage Temperature		T _{stg}	−55~+125	°C	
焊接温度 Soldering Temperature		T _{sol}	260	°C	

推荐的操作条件 Recommended Operating Conditions

参数 Parameter	符号 Symbol	最小 Min.	最大 Max.	单位 Unit	备注 Note
输入电流 (ON) Input Current (ON)	$I_{F(ON)}$	5	10	mA	
输入电压 (OFF) Input Voltage (OFF)	$V_{F(OFF)}$	-5	0.4	V	
工作温度 Operating Temperature	T_A	-40	+105	°C	
持续负载电压 Continuous Load Voltage	V_O	-	1500	V_{DC}	
负载电流 Load Current	I_O	-25	25	mA	

产品特性参数 Electro-optical Characteristics (T_A=25°C)

参数 Parameter		符号 Symbol	条件 Condition	最小 Min.	典型 Typ.	最大 Max.	单位 Unit
发射端 Input	LED 开启电流 LED Operate Current	I _{Fon}	I _L = 50mA.	-	1.2	3	mA
	LED 关断电流 LED Turn Off Current	I _{Foff}	I _L = 50mA	0.2	1.0	-	mA
	LED 正向压降 LED Dropout Voltage	V _F	I _F = 5mA	-	1.35	1.5	V
接收端 Output	负载电压 (AC 峰值) Load Voltage (Peak AC)	V _L	I _{Off} =10uA	1800	-	-	V
	导通电阻 On Resistance	R _{on}	I _F = 5mA I _L = 50mA. Within 1s on time	-	36	80	Ω
	关断漏电 Off State Leakage Current	I _{Lleak}	I _F = 0mA V _L = 1800V	-	0.3	10	μA
传输特性 Transfer Characteristics	开启时间 Turn On Time	T _{on}	I _F = 5mA I _L = 50mA.	-	255	1500	us
	关断时间 Turn Off Time	T _{off}	I _F = 5mA I _L = 50mA.	-	170	500	us

典型光电特性曲线 Typical Electro-Optical Characteristics Curves

Fig.1 LED Dropout Voltage vs. Ambient Temperature

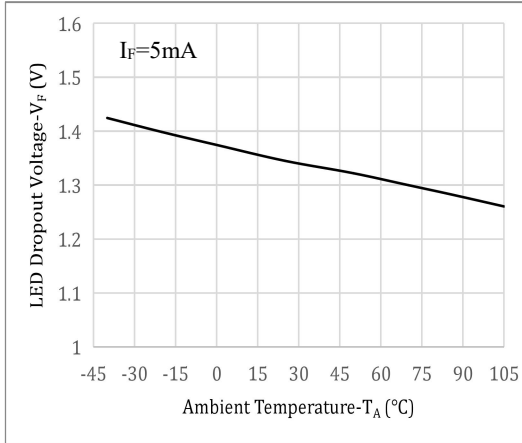


Fig.2 Output Current vs. Output Voltage

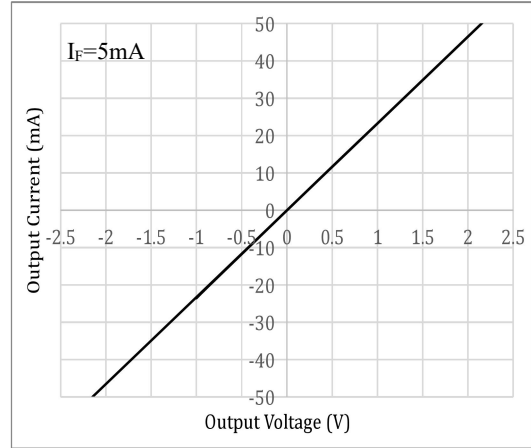


Fig.3 On Resistance vs. Ambient Temperature

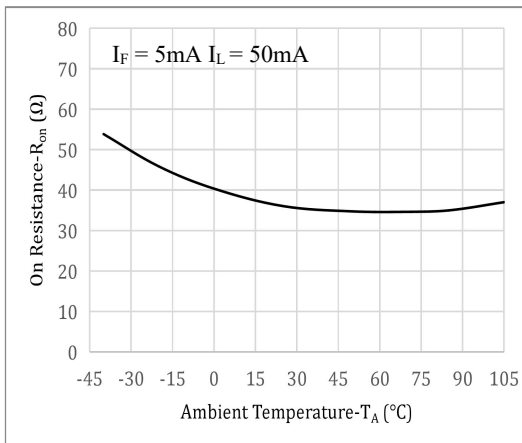


Fig.4 Off State Leakage Current vs. Ambient Temperature

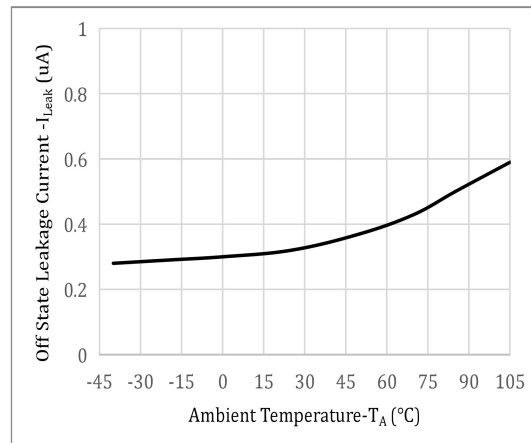


Fig.5 LED Operate Current vs. Ambient Temperature

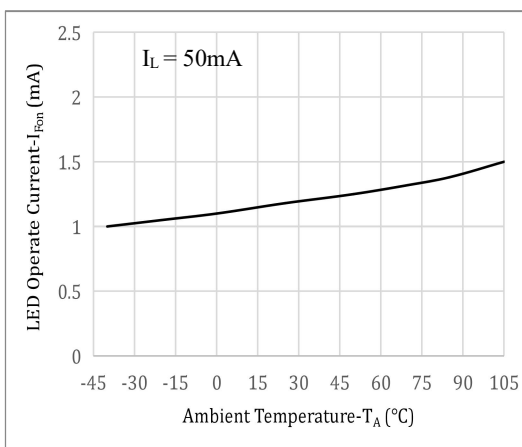


Fig.6 LED Turn Off Current vs. Ambient Temperature

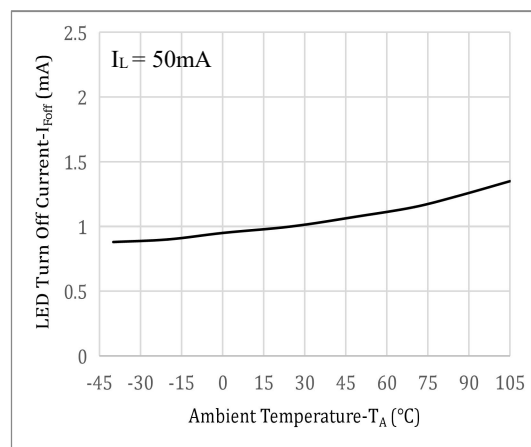


Fig.7 Turn On Time vs. Ambient Temperature

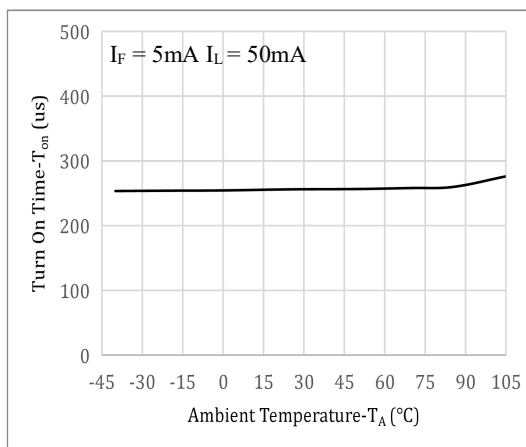


Fig.8 Turn Off Time vs. Ambient Temperature

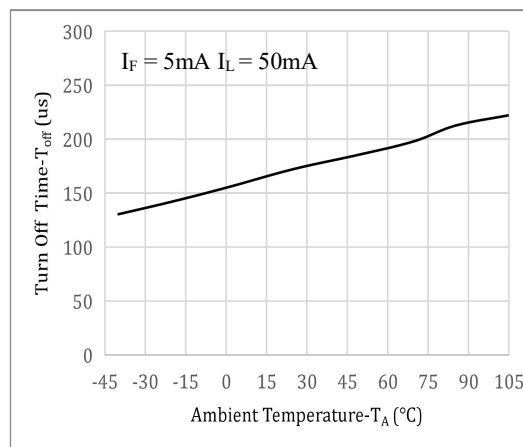


Fig.9 Turn On Time vs. LED Forward Current

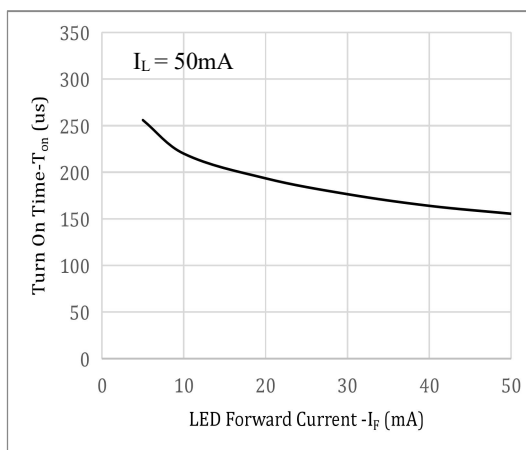
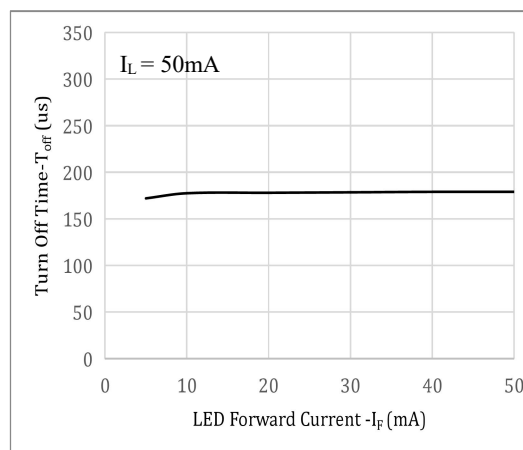
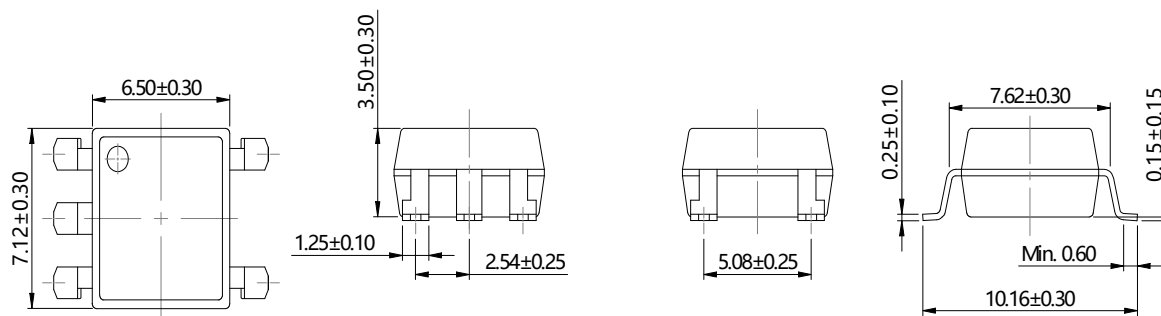


Fig.10 Turn Off Time vs. LED Forward Current



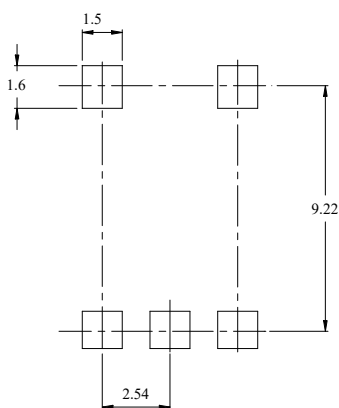
外形尺寸 Outline Dimensions

SMD5



单位 Unit: mm

建议焊盘布局 Recommended Pad Layout

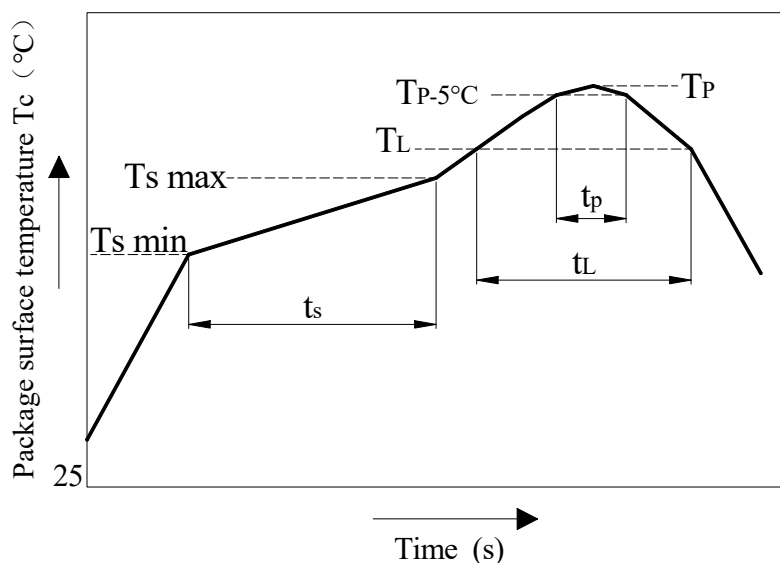


单位 Unit: mm

注：上图及产品正视图。

Note: The picture above is the front view of the product.

回流焊温度曲线图 Solder Reflow Profile

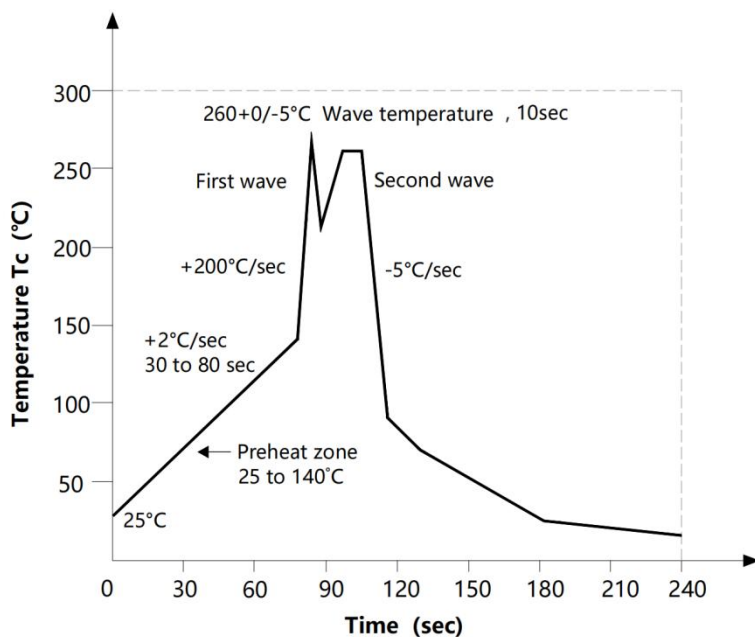


项目 Item	符号 Symbol	最小值 Min.	最大值 Max.	单位 Unit
预热温度 Preheat Temperature	T_s	150	200	°C
预热时间 Preheat Time	t_s	60	120	s
升温速率 Ramp-Up Rate (T_L to T_P)	-	-	3	°C/s
液相线温度 Liquidus Temperature	T_L	217		°C
时间高于 T_L Time Above T_L	t_L	60	150	s
峰值温度 Peak Temperature	T_P	-	260	°C
T_c 在 (T_P-5) 和 T_P 之间的时间 Time During Which T_c Is Between (T_P-5) and T_P	t_p	-	30	s
降温速率 Ramp-down Rate(T_P to T_L)	-	-	6	°C/s

注：建议在所示的温度和时间条件下进行回流焊，最多不能超过三次。

Note: Reflow soldering is recommended at the temperatures and times shown, no more than three times.

波峰焊温度曲线图 Wave Soldering Profile



手工烙铁焊接 Soldering with hand soldering iron

A. 手工烙铁焊仅用于产品返修或样品测试;

Hand soldering iron is only used for product rework or sample testing;

B. 手工烙铁焊要求: 温度 $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$, 时间 $\leq 3\text{s}$ 。

Manual soldering method Temperature: $360^{\circ}\text{C} \pm 5^{\circ}\text{C}$, within 3s.

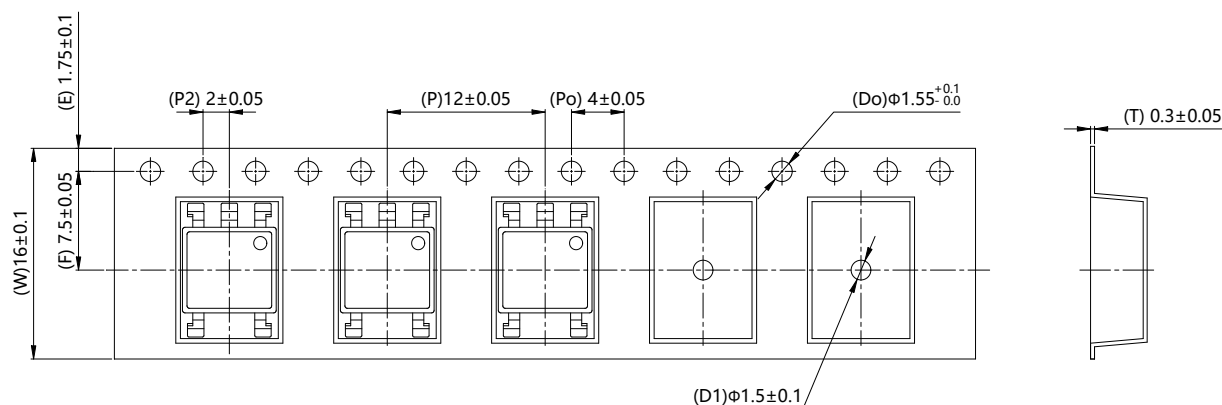
包装 Packing

■ 汇总表 Summary table

封装形式	包装方式	盘数量	盒数量	箱数量	静电袋规格	盒规格	箱(双瓦楞)规格	备注
SMD5	卷盘 ($\phi 330$ mm 蓝盘)	1000 只/盘	2 盘/盒	10 盒/箱	450*390*0.1mm	353*340*60mm	650*375*365mm	首端空 50 个空格, 末端空 100 个空格
Package Type	Packing Form	Quantity per Reel	Quantity per Box	Quantity per Carton	Antistatic Bag Specification	Box Specification	Carton Specification	Note
SMD5	Reel ($\phi 330$ mm Blue)	1000 pcs/reel	2 reels/box	10 boxes/ctn	450*390*0.1mm	353*340*60mm	650*375*365mm	Leave 50 Spaces at the beginning and 100 Spaces at the end

■ 编带包装 Tape & Reel

- 1) 每卷数量: 1000 只。
Qty/reel: 1000 pcs.
- 2) 每箱数量: 20000 只。
Qty/ctn: 20000 pcs.
- 3) 内包装: 每盒 2 盘。
Inner packing: 2 reels/box.
- 4) 示意图 Schematic:



单位 Unit: mm

注意 Attention

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